

# Difference among various products of 3826 Group

Renesas Technology Corporation Renesas LSI Design Corporation Renesas Solutions Corporation

RenesasTechnologyCorp.



### **Products effected**

- Emulator MCU Standard version M38267RLFS
- One-time PROM version Standard version M38267E8FP/GP, M3826AEFFP/GP
- Mask ROM version L version (Low voltage version : 2.2v) M38267M8LXXXFP/GP, M38268MCLXXXFP/GP, M3826AMFLXXXFP/GP
- Mask ROM version A version M38268MCA-XXXFP/GP, M3826AMFA-XXXFP/GP

# **Precaution**

 When Mask ROM version, One-time PROM version and memory size differ in one group, actual values such as an electrical characteristics, operation margin, A-D conversion accuracy, noise immunity, and noise radiation may differ from the ideal values due to the difference in the manufacturing processes.
When these products are used switching, perform system evaluation for each product of every after confirming product specification.

- This document shows difference, some specifications and standards, not for all.

Be sure to refer to the most current data sheet as for the latest detailed specification and an electrical characteristics.

# 1. Difference among various products of 3826 Group



		One-time PROM version		Mask ROM	Mask ROM version(A version)				
		38267E8	3826AEF	38267M8L	38268MCL, 3826AMFL	38268MCA, 3826AMFA			
ROM/RAM size[byte]		32K/1K	60K/2.5K	32K/1K	60K/2.5K, 48K/1.5K	60K/2.5K, 48K/1.5K			
Oscillation circuit constants		The oscillation circuit constants of XIN-XOUT, XCIN-XCOUT will depend on each product.							
Hysteresis characteristics (See 3.section)		Almost fixed	÷	÷	It depends on the power supply and becomes narrow.	÷			
Circuit structure of the peripheral function input pins		See 4.section							
sub-clock oscillation circuit		Without regulator	÷	÷	÷	With regulator			
Vpp power supply pin connection (P70)		Serial resistor (5k ) is necessary.Make the length of wiring which is connected to the Vpp pin as short as possible. It protects input noise.		Serial resistor is unnecessary.	÷	÷			
Absolute Maximum ratings	Power source voltage(Vcc) Input voltage (C1, C2) Output voltage (VL3) Output voltage (C1, C2)	-0.3V to 7.0V	÷	÷	-0.3V to 6.5V	÷			
	Input voltage (VL3)	VL2 to 7.0V	÷	÷	VL2 to 6.5V	÷			
Power source current		See 6.section							
Power supply(Vcc) / Main-clock input oscillation frequency		See 7.1. and 7.2. Section							
RAM retention voltage (Min.)		2.0V	÷	÷	÷	1.8V			
Reference power source input current (DA) (IVREF )		6.0mA	3.2mA	6.0mA	3.2mA	÷			
Power source voltage of VLI (At using voltage multiplier)		1.3V to 2.3V	÷	÷	1.3V to 2.1V	÷			
Timer X,Y input frequency (Max.) f(CNTR0),f(CNTR1)		2.5<=Vcc<=4.0V : (2 x Vcc - 4) MHz 4.0<=Vcc<=5.5V : 4 MHz	2.5<=Vcc<=4.0V : (2 x Vcc - 4) MHz 4.0<=Vcc<=5.5V : 4 MHz	2.2<=Vcc<=4.0V : (10 x Vcc - 4)/9 MHz 4.0<=Vcc<=5.5V : 4 MHz	2.2<=Vcc<=4.0V : (10 x Vcc - 4)/9 MHz 4.0<=Vcc<=5.5V : 4 MHz	1.8<=Vcc<=2.0V : (5 x Vcc - 8) MHz 2.0<=Vcc<=4.0V : (Vcc) MHz 4.0<=Vcc<=4.5V : (2 x Vcc - 4) MHz 4.5<=Vcc<=5.5V : 5 MHz			

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The oscillation circuit constants of XIN-XOUT, XCIN-XCOUT will depend on each product of Mask ROM version (L version, A version) and One-time PROM version.

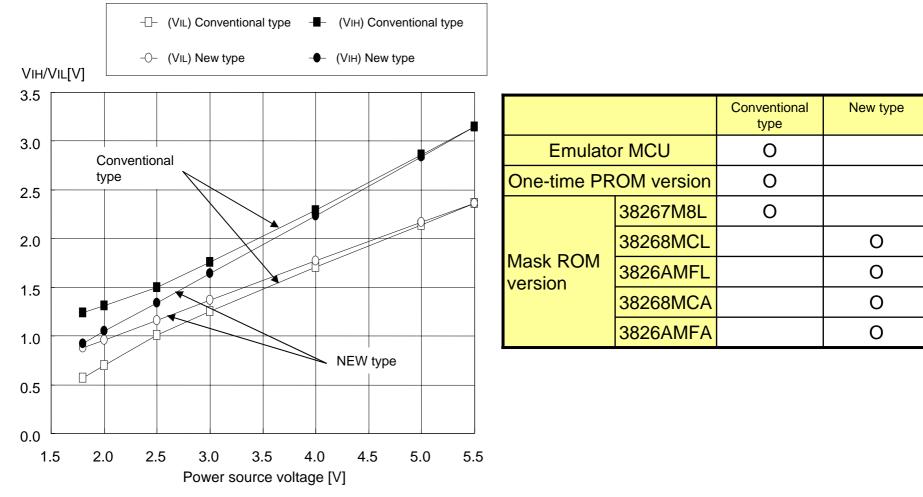
So that the product used for mass production obtains the stabilized operation clock on the user system and its condition, contact the resonator manufacturer and select the resonator and oscillation circuit constants. Be careful especially when range of voltage and temperature is wide.

We recommend to design the circuit in consideration of the wiring pattern of the feed-back resistor, the dumping resistor and the load capacity in advance.

We publish the reference-use oscillation circuit parameters in Renesas Technology home page.

http://www.renesas.com/en/38000





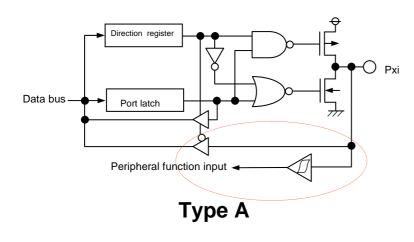
Note: Data described here are characteristic examples.

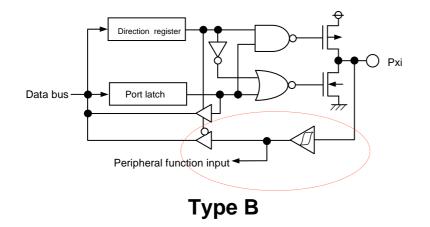
The data values are not guaranteed.

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# 4. Circuit structure of the peripheral function input pins







Type A : Input level of port does not always correspond with it of the peripheral function input pin.

Type B : Input level of port corresponds with it of the peripheral function input pin. (The port input also has hysteresis.)

		Туре А	Type B		
Emulator MCU		0			
One-time PROM version		0			
	38267M8L	0			
	38268MCL		0		
Mask ROM version	3826AMFL		0		
	38268MCA		0		
	3826AMFA		0		

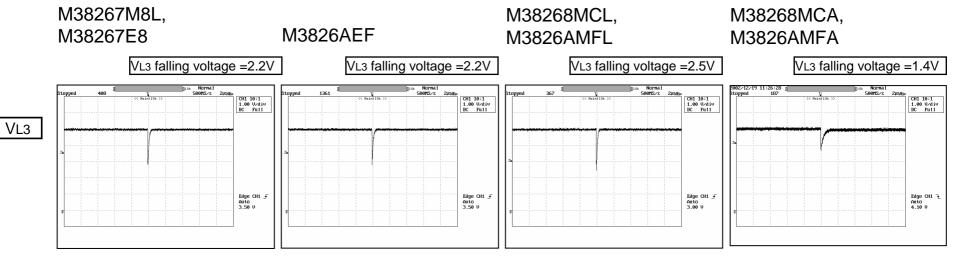
Pins ;

P20 to P27, P41/INT1, P42/INT2, P44/RxD, P46/SCLK1, P54/CNTR0, P55/CNTR1, P57/ADT, P60/SIN2, P62/SCLK21, P70/INT0

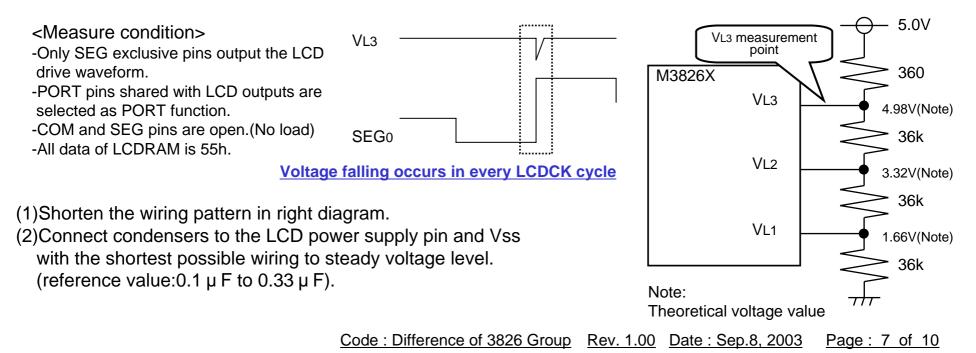
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# 5. LCD power supply pins





Note: Data described here are characteristic examples. The data values are not guaranteed.

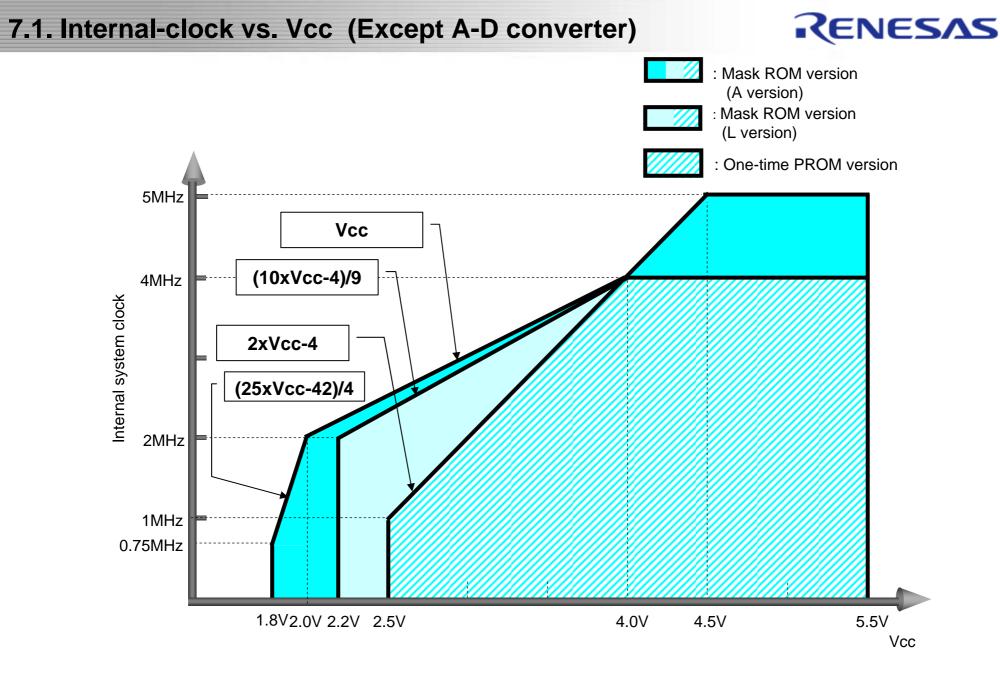


# 6. Electrical characteristics (Power source current)



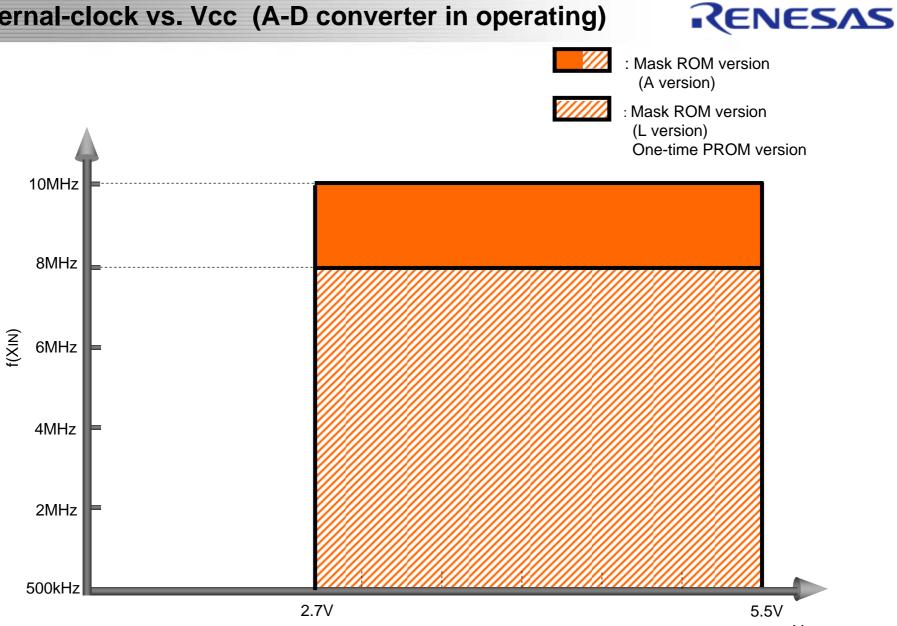
Symbol	Parameter	Test conditions	38267M8L 38267E8		38268MCL 3826AMFL 3826AEF		38268MCA 3826AMFA		Unit
				Max.	Тур.	Max.	Тур.	Max.	
Icc	Power source current	High-speed mode, $Vcc = 5V$ , $f(XIN) = 10MHz$ , $f(XCIN) = 32.768kHz$ Output transistors "off", A-D converter in operating	-	-	-	-	5.5	11.0	mA
		High-speed mode, $Vcc = 5V$ , $f(XIN) = 8MHz$ , $f(XCIN) = 32.768$ kHz Output transistors "off", A-D converter in operating	8.0	15	8.0	15	4.5	9.0	mA
		High-speed mode, Vcc = 5V, f(XIN) = 8MHz (in WIT state), f(XCIN) = 32.768kHz, Output transistors "off", A-D converter stop	2.5	4.0	2.5	4.0	1.2	2.4	mA
		Low-speed mode, Vcc = 5V, Ta <= 55 ° C, f(XIN) = stopped f(XCIN) = 32.768kHz, Output transistors "off"	45	67	45	67	15	30	μA
		Low-speed mode, Vcc = 5V, Ta =25 ° C, f(XIN) = stopped f(XCIN) = 32.768kHz(in WIT state), Output transistors "off"	23	46	23	46	7	14	μA
		Low-speed mode, Vcc = 3V, Ta <= 55 ° C, f(XIN) = stopped f(XCIN) = 32.768kHz, Output transistors "off"	18	36	18	36	9	18	μA
		Low-speed mode, Vcc = 3V, Ta =25 ° C, $f(XIN)$ = stopped f(XCIN) = 32.768kHz(in WIT state), Output transistors "off"	8.0	16	8.0	16	4.5	9	μA
		All oscillation stopped (in STP state), Ta =25 ° C, Output transistors "off"	0.5	10	0.1	1.0	0.1	1.0	μA
		All oscillation stopped (in STP state), Ta =55 ° C, Output transistors "off"	-	60	-	-	-	-	μA
		All oscillation stopped (in STP state), Ta =85 ° C, Output transistors "off"	-	-	-	10	-	10	μA

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### 7.2. External-clock vs. Vcc (A-D converter in operating)



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Renesas Electronics website: http://www.renesas.com

April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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